Amendments to the Claims:

This listing of claims will replace all prior versions, and listings, of claims in the application:

Listing of claims:

Claim 1 (currently amended). A thyristor structure, comprising:

a first terminal formed as a first region having a first conductivity type;

a second region of a second conductivity type adjoining said first region;

a third region of the first conductivity type adjoining said second region and having a common surface with said second region;

a second terminal functioning as a fourth region, formed of the second conductivity type, and adjoining said third region;

said first terminal and said second terminal each being connected to a respective one of a first potential and a second potential;

auxiliary electrodes disposed on said common surface and each adjoining one of said second and third regions, said auxiliary electrodes being formed as gate electrodes, said auxiliary electrodes being electrically conductively connected with a respective one of said first terminal and said second terminal, and said auxiliary electrodes being so formed on said common surface that no parasitic effect between said first terminal and said second terminal leads to a conductive state between said two terminals; and

a control terminal for controlling the thyristor structure by an applied current embodied in one of said second region and said third region, said control terminal being formed of the same conductivity type as a surrounding region thereof.

Claim 2 (original). The thyristor structure according to claim 1, wherein said auxiliary electrodes are each formed from a conductive region made of polysilicon and an auxiliary oxide insulating said conductive region from said common surface.

Claim 3 (currently amended). An overvoltage protection configuration, comprising:

a thyristor structure containing:

Applic. No.: 10/657,899 Amdt. Dated March 21, 2006

Reply to Office action of December 21, 2005

a first terminal formed as a first region having a first conductivity type;

a second region of a second conductivity type adjoining said first region;

a third region of the first conductivity type adjoining said second region and having a common surface with said second region;

a second terminal functioning as a fourth region, formed of the second conductivity type, a component to be protected disposed in an electrically conductive manner between said first terminal and said second terminal;

said first terminal and said second terminal each being connected to a respective one of a first potential and a second potential;

auxiliary electrodes disposed on said common surface and each adjoining one of said second and third regions, said auxiliary electrodes being formed as gate electrodes, said auxiliary electrodes being electrically conductively

connected with a respective one of said first terminal and said second terminal, and said auxiliary electrodes being so formed on said common surface that no parasitic effect between said first terminal and said second terminal leads to a conductive state between said two terminals; and

a control terminal for controlling the thyristor
structure by an applied current embodied in one of said
second region and said third region, said control
terminal being formed of the same conductivity type as a
surrounding region thereof; and

an overvoltage detector connected to and detecting an overvoltage across the component to be protected.

Claim 4 (original). The overvoltage protection configuration according to claim 3, wherein said control terminal forms a fifth region and is formed of the first conductivity type, said fifth region having a higher conductivity than said third region.

Claim 5 (original). The overvoltage protection configuration according to claim 3, wherein a supply voltage of the

component to be protected is connected to said first terminal and to said second terminal.

Claim 6 (currently amended). An overvoltage protection configuration, comprising:

a single semiconductor chip;

a thyristor structure integrated in said single semiconductor chip and containing:

a first terminal formed as a first region having a first conductivity type;

a second region of a second conductivity type adjoining said first region;

a third region of the first conductivity type adjoining said second region and having a common surface with said second region;

a second terminal functioning as a fourth region, formed of the second conductivity type, a component to be protected disposed in an electrically conductive manner between said first terminal and said second terminal;

said first terminal and said second terminal each being connected to a respective one of a first potential and a second potential;

auxiliary electrodes disposed on said common surface and each adjoining one of said second and third regions, said auxiliary electrodes being formed as gate electrodes, said auxiliary electrodes being electrically conductively connected with a respective one of said first terminal and said second terminal, and said auxiliary electrodes being so formed on said common surface that no parasitic effect between said first terminal and said second terminal leads to a conductive state between said two terminals;

a control terminal for controlling the thyristor
structure by an applied current embodied in one of said
second region and said third region, said control
terminal being formed of the same conductivity type as a
surrounding region thereof; and

an overvoltage detector connected to and detecting an overvoltage across the component to be protected.